

Overview

HP ZBook Studio x360 G5 Mobile Workstation



- 1. HP ZBook x360 Pen (optional)
- 2. HP x360 hinge
- 3. HD Camera

- 4. IR Camera
- 5. Microphone

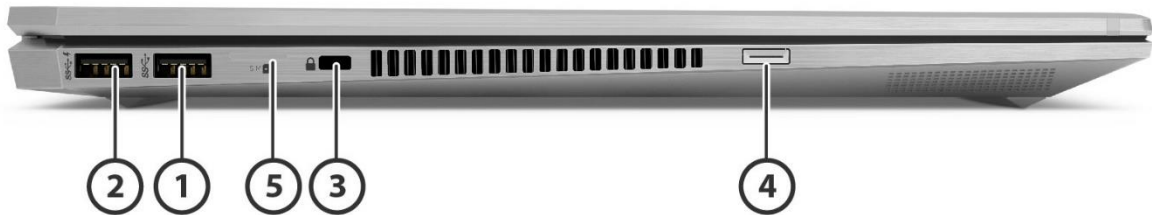
Overview



FRONT VIEW

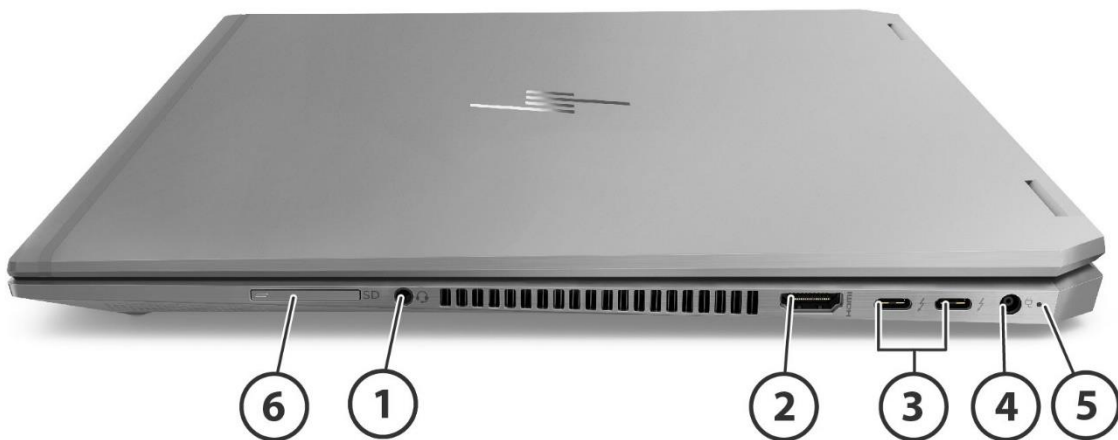
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|----|--------------------|----|--------------------|
| 1. | Clickpad | 3. | Speakers |
| 2. | Fingerprint sensor | 4. | Collaboration Keys |

Overview



LEFT VIEW

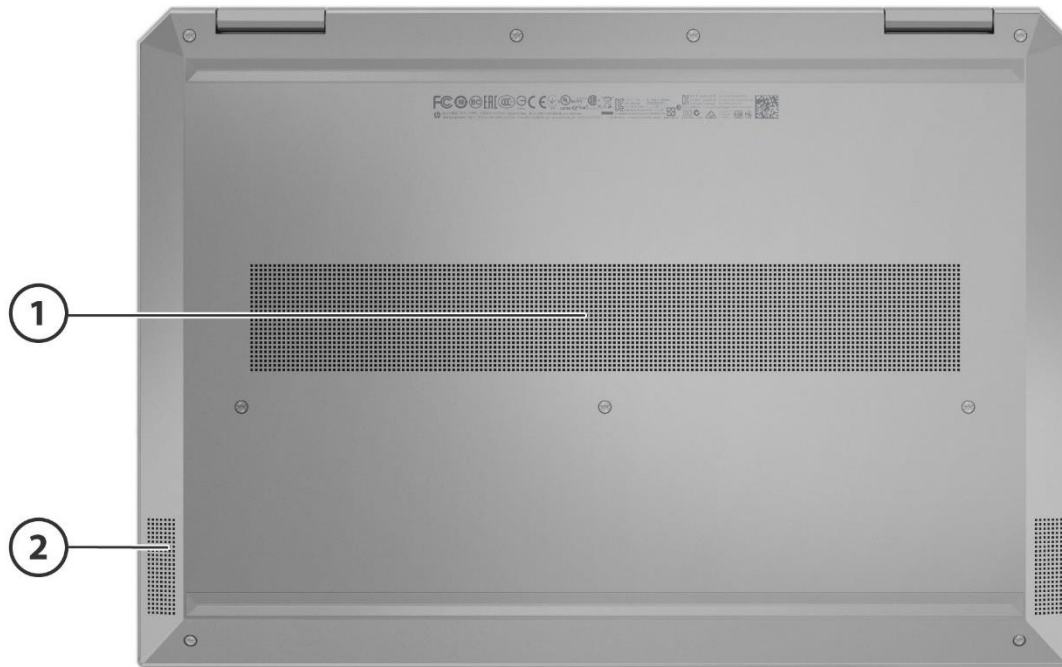
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|--------------------------|------------------------|
| 1. USB 3.0 | 3. Security cable slot |
| 2. USB 3.0 charging port | 4. Power Button |
| | 5. Micro SIM slot |



RIGHT VIEW

- | | |
|--|--------------------|
| 1. Stereo microphone in / headphone-out combo jack | 4. Power connector |
| 2. HDMI 2.0 | 5. Power LED |
| 3. Thunderbolt™ 3 ports | 6. SD Card Reader |

Overview



BOTTOM VIEW

1. Fan Venting

2. Speakers

Overview

At A Glance

- New convertible design with 5 versatile modes (laptop, tablet, stand, tent, dock) delivering workstation-class performance in every mode. 15.6" diagonal design starting at just 4.99 pounds.
- X360 form factor with pen and touch capabilities allows users new ways to complete their workflows quicker and easier; HP ZBook x360 Pen provides 4,096 points of pressure sensitivity and a great inking experience for creation and annotation.
- Tested and passed 14 MIL-STD-810G tests*.
- Workstation-caliber NVIDIA® Quadro® discrete graphics featuring NVIDIA® Optimus technology:
 - NVIDIA® Quadro® P1000 4GB GDDR5
 - NVIDIA® Quadro® P2000 4GB GDDR5
- Intel® Integrated graphics: Intel® UHD Graphics 630 integrated on Intel® Core™ i7 and Core™ i9 processors and Intel® UHD Graphics P630 integrated on Intel® Xeon® processors.
- ISV certified to provide fast and reliable performance with workstation applications, including manipulation of 3D textures
- Choice of eight-core 9th Generation Intel® Core™ i9 processors, six-core Intel® Xeon® processors, 9th Generation Intel® Core™ i7 processors, 8th Generation Intel® Core™ i9 or Core™ i7 or quad-core 8th Generation Core™ i5 processor.
- Intel® Core™ i9 with vPro™, Intel® Core™ i7 with vPro™, Intel® Core™ i5 with vPro™ technology or Intel® Xeon® with vPro™ technology (optional)
- HP Performance Advisor for optimal configuration, stability, compatibility and best performance
- Up to two SODIMMs supporting up to 32 GB DDR4-2667 MHz dual channel memory (up to 64GB DDR4-2667 MHz configuration coming in December 2018). ECC memory available with Intel® Xeon® processors.
- Featuring HP Collaboration Keyboard with Clickpad to manage most commonly used conferencing functions with a single keystroke
- Innovative HP World-Facing third mic supports HP Noise Cancellation Software.
- Supports multi-display, including up to three (3) displays without a docking solution, with hybrid graphics enabled. Supports up to five (5) displays with HP Thunderbolt™ Dock G2 (sold separately), with hybrid graphics enabled.
- Two (2) Thunderbolt™ 3 ports (supporting DP 1.3, USB 3.1, PCIe Gen 3 devices) on the new USB-C™ connector, for high speed data/video/audio transfer support.
- Audio by Bang and Olufsen optimized for high fidelity audio with immersive surround sound with deep, rich bass and crystal-clear dialog without distortion at high volume, and new discrete amp.
- HP Long life battery solution: 4-cell (64 Whr) or 6-cell (96 Whr) supporting HP Fast Charge: charges 50% of the battery in 45 minutes.
- 15.6-inch diagonal LED-backlit display:
 - FHD IPS eDP + PSR touch screen with Corning® Gorilla® Glass 3, 400 nits with ambient light sensor 100% sRGB (1920x1080)
 - HP Sure View FHD IPS eDP + PSR touch screen with Corning® Gorilla® Glass 3, 650nits sRGB (1920x1080)
 - UHD IPS eDP + PSR touch screen with Corning® Gorilla® Glass 3, 400 nits with ambient light sensor 100% sRGB (3840x2160)
 - HP DreamColor Technology UHD IPS eDP + PSR touch screen with Corning® Gorilla® Glass 3, 600 nits, 100% Adobe RGB (3840x2160)
 - HP DreamColor Technology UHD IPS eDP + PSR anti-glare touch screen with Corning® Gorilla® Glass 3, 600 nits, 100% Adobe RGB (3840x2160)
- Wireless connectivity options:
 - Intel® Dual Band Wireless-AC 9560 802.11 AC/a/b/g/n (2x2) WLAN and Bluetooth® 5.0 combo adaptor (vPro™)
 - Intel® Dual Band Wireless-AC 9560 802.11 AC/a/b/g/n (2x2) WLAN and Bluetooth® 5.0 combo adaptor (non-vPro™)
 - Optional integrated wireless 4G (LTE) mobile broadband module support
- Three (3) dedicated drive slots, two (2) M.2 slots, and one (1) 2.5" drive supporting up to 5 TB of storage
- Enterprise grade security with HP SureStart Gen4, HP Privacy Camera³, HP Sure View², HP Sure Run, HP Sure Recover, and Fingerprint sensor², plus optional RAID 1** (mirroring) from HP.

*MIL STD 810G testing is not intended to demonstrate fitness for U.S. Department of Defense contract requirements or for military use. Test results are not a guarantee of future performance under these test conditions. Accidental damage requires an optional HP Accidental Damage Protection Care Pack.

Overview

** RAID 1 Configuration requires 2 NVMe PCIe M.2 drives; both drives must be the same capacity and only available on NVMe technology.

NOTE: See important legal disclosures for all listed specs in their respective features sections.

Features

OPERATING SYSTEM

Preinstalled

Windows 10 Pro 64 – HP recommends Windows 10 Pro*
Windows 10 Pro for Workstations 64*
Windows 10 Home 64 *

FreeDOS 2.0

Supported

Windows 10 Enterprise 64*
RedHat® Enterprise Linux® (REHL) 7
Ubuntu Linux 16.04
For additional Linux OS information, please reference our Linux Hardware Matrix:
<http://h10032.www1.hp.com/ctg/Manual/c00060684.pdf>

*Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows 10 is automatically updated, which is always enabled. ISP fees may apply and additional requirements may apply over time for updates. See <http://www.windows.com>

PROCESSOR*

9th Generation Intel® Core™ i7 9750H with Intel® UHD Graphics 630 (2.6 GHz base frequency, up to 4.5 GHz with Intel® Turbo Boost Technology, 12 MB cache, 6 cores)

9th Generation Intel® Core™ i7 9850H with Intel® UHD Graphics 630 (2.6 GHz base frequency, up to 4.6 GHz with Intel® Turbo Boost Technology, 12 MB cache, 6 cores)

9th Generation Intel® Core™ i9 9980H with Intel® UHD Graphics 630 (2.3 GHz base frequency, up to 4.8 GHz with Intel® Turbo Boost Technology, 16 MB cache, 8 cores)

9th Generation Intel® Core™ i9 9980HK with Intel® UHD Graphics 630 (2.4 GHz base frequency, up to 5.0 GHz with Intel® Turbo Boost Technology, 16 MB cache, 8 cores)

8th Generation Intel® Core™ i5-8300H with Intel® UHD Graphics 630 (2.3 GHz (up to 4.0 GHz)/2667 MHz/ 8 MB L3 cache/45W)

8th Generation Intel® Core™ i5-8400H vPro™ processor with Intel® UHD Graphics 630 (2.5 GHz (up to 4.2 GHz)/2667 MHz/ 8 MB L3 cache/45W)

8th Generation Intel® Core™ i7-8750H with Intel® UHD Graphics 630 (2.2 GHz (up to 4.1 GHz)/2667 MHz/ 9 MB L3 cache/45W)

8th Generation Intel® Core™ i7-8850H vPro™ processor with Intel® UHD Graphics 630 (2.6 GHz (up to 4.3 GHz)/2667 MHz/ 9 MB L3 cache/45W)

8th Generation Intel® Core™ i9-8950HK processor with Intel® UHD Graphics 630 (2.9 GHz base frequency, up to 4.8 GHz with Intel® Turbo Boost Technology, 12 MB cache, 6 cores)

Intel® Xeon® E-2176M vPro™ processor with Intel® UHD Graphics P630 (2.7 GHz (up to 4.4 GHz)/2667 MHz/12 MB L3 cache/45W)

Intel® Xeon® E-2186M vPro™ processor with Intel® UHD Graphics P630 (2.9 GHz (up to 4.6 GHz)/2667 MHz/12 MB L3 cache/45W)

* Multicore is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. Performance and clock frequency will vary depending on application workload and your hardware and software configurations. Intel's numbering, branding and/or naming is not a measurement of higher performance.

** Some functionality of Intel® Core™ i5 with vPro™/Core™ i7 with vPro™/Core™ i9 with vPro™/Xeon® with vPro™ technology, such as Intel® Active Management technology and Intel® Virtualization technology, requires additional third- party software in order to run. Availability of future "virtual appliances" applications for Intel® Core™ i5 with vPro™/Core™ i7 with vPro™/ Core™ i9 with vPro™/XEON® with vPro™ technology is dependent on third- party software providers. Compatibility with future "virtual appliances" is yet to be determined.

*** Intel Turbo Boost performance varies depending on hardware, software and overall system configuration. See www.intel.com/technology/turboboost for more information.

Features

NOTE: In accordance with Microsoft's support policy, HP does not support the Windows® 8 or Windows 7 operating system on products configured with Intel® and AMD 7th generation and forward processors or provide any Windows®8 or Windows 7 drivers on <http://www.support.hp.com>

Features

CHIPSET

Mobile Intel® CM246

INTEL® CORE™ I5 WITH VPRO/CORE I7 WITH VPRO/XEON® WITH VPRO TECHNOLOGY CAPABLE

Intel® Core™ i5 with vPro™, Core™ i7 with vPro™ and XEON® with vPro™ technology is a selectable feature that is available on units configured with select processors, a qualified Intel® WLAN module and a preinstalled Windows® operating system. It provides advances in remote manageability, security, energy efficient performance, and wireless connectivity. Intel® Active Management Technology (iAMT) offers built-in manageability and proactive security for networked mobile workstations, even when they are powered off* or when the operating system is inoperable. It can help identify threats before they reach the network, isolate infected systems, and update regardless of their power state.

* Requires a Windows operating system, network hardware and software, connection with a power source, and a direct (non-VPN) corporate network connection which is either cable or wireless LAN.

NOTE: Some functionality of Intel® Core™ i5 with vPro™/Core™ i7 with vPro™/ Core™ i9 with vPro™/Xeon® with vPro™ technology, such as Intel® Active Management technology and Intel® Virtualization technology, requires additional third-party software in order to run. Availability of future "virtual appliances" applications for Intel® Core™ i5 with vPro™/Core i7 with vPro™/XEON® with vPro™ technology is dependent on third-party software providers. Compatibility with future "virtual appliances" is yet to be determined.

Features

GRAPHICS

Integrated

Intel® UHD graphics 630^{1,2}
Intel® UHD graphics P630^{1,2}

Discrete^{3,4}

NVIDIA® Quadro® P1000 with 4 GB dedicated GDDR5 video memory
Microsoft DirectX 12 (Shader Model 5.0) and OpenGL 4.4 capable
NVIDIA® Quadro® P2000 with 4 GB dedicated GDDR5 video memory
Microsoft DirectX 12 (Shader Model 5.0) and OpenGL 4.4 capable

NOTE 1: UHD content required to view UHD images

NOTE 2: Intel® UHD graphics 630 is configurable as a standalone graphics option; Intel® UHD graphics P630 only used when NVIDIA® Optimus™ Technology is enabled.

NOTE 3: NVIDIA® Quadro® mobile professional graphics support up to four independent displays when using a HP ZBook Dock with Thunderbolt™ 3 (sold separately) or DP 1.2 hubs with MST.

Note 4: Must be configured with the 6-cell 96 WHr battery; cannot be configured with a Hard Disk Drive.

NOTE: Intel® UHD Graphics 630 integrated on Core™ i9, Core™ i7 and Core™ i5 processors. Intel® UHD Graphics P630 integrated on Xeon® processors.

DisplayPort™ 1.3 protocol features supported on Thunderbolt™ 3 ports:

- Legacy displays (HDMI, DVI, VGA) may be attached to Thunderbolt™ port with the use of a certified dongle.
- DisplayPort™ monitors capable of supporting DisplayPort™ 1.3 may be directly attached to the Thunderbolt™ port to achieve HBR2 with the use a dongle.
- Thunderbolt™ 3 enabled monitors may be directly attached to the Thunderbolt™ port to achieve HBR2 and MST.
- DisplayPort™ 1.3 MST feature ("daisy-chain" feature) is supported through Thunderbolt™ 3 port on Thunderbolt™ 3 enabled devices or DisplayPort™ 1.3 monitors (requires monitor with DisplayPort™ 1.3 MST capability) with the use of a dongle.
- Up to 2 streams (eight lanes) of DisplayPort™ 1.3 are supported over a single Thunderbolt™ 3 port. Up to (2) 4K displays 24/30-bit color depth at 60 Hz or (1) 5K display supported over a single Thunderbolt™ 3 port. (Requires Intel® certified Thunderbolt™ cable).
- DisplayPort™ 1.3 w/MST (Multi-stream Transport): Supports resolutions up to Full 4K, 24/30-bit color depth at 60 Hz, and WUXGA (1920 x1200) monitors, 24/30-bit color depth at 120 Hz.

*Thunderbolt™ 3 is superset port supporting DisplayPort™ 1.3, USB 3.1 Gen 2, and PCIe Gen 3 devices over the new USB-C™ connector. Install all the latest drivers for your Thunderbolt™ device before connecting the device to the Thunderbolt™ port. Thunderbolt™ cable and Thunderbolt™ device (sold separately) must be compatible with Windows. To determine whether your device is Thunderbolt™ Certified for Windows, see <https://Thunderbolttechnology.net/products>.

Multi-Display Support

Without HP Thunderbolt Dock G2:

HP ZBook Studio x360 with hybrid graphics and without the use of the ZBook dock supports up to a maximum of three independent displays. These three displays are the internal panel plus two external displays connected to two of the three following ports: HDMI 2.0, Thunderbolt™ 3, Thunderbolt™ 3. HP ZBook Studio x360 configuration with Intel® integrated

Features

graphics and without the use of the ZBook dock supports up to a maximum of three independent displays. Any three display combination of the system panel HDMI, Thunderbolt™ 3, Thunderbolt™ 3.

With HP Thunderbolt Dock G2:

The HP Thunderbolt Dock G2 has Thunderbolt™ 3 port, VGA, two DisplayPort™ 1.3, and a USB-C port. When used together with the HP ZBook Studio x360 configuration with hybrid graphics, a maximum of five independent displays are supported. These five displays are internal panel and four external displays connected to the ZBook dock's Thunderbolt™ 3, VGA, and two DisplayPort™ ports. When used together with the HP ZBook Studio x360 configuration with Intel® integrated graphics, a maximum of 3 independent displays are supported. Any three-display combination of the system panel, system ports and ZBook Dock ports.

DISPLAY

Internal

- 15.6-inch diagonal FHD IPS eDP + PSR LED-backlit touch screen display with Corning® Gorilla® Glass 4, 400 nits with ambient light sensor 100% sRGB (1920x1080)
- HP Sure View 15.6-inch diagonal FHD IPS eDP + PSR LED-backlit touch screen display with Corning® Gorilla® Glass 4, 650nits 100% sRGB (1920x1080)
- 15.6-inch diagonal UHD IPS eDP + PSR LED-backlit touch screen display with Corning® Gorilla® Glass 4, 400 nits with ambient light sensor 100% sRGB (3840x2160)
- HP DreamColor Technology 15.6-inch diagonal UHD IPS eDP + PSR LED-backlit touch screen display with Corning® Gorilla® Glass 4, 600 nits, 100% Adobe RGB (3840x2160)
- HP DreamColor Technology 15.6-inch diagonal UHD IPS eDP + PSR LED-backlit anti-glare touch screen display with Corning® Gorilla® Glass 4, 600 nits, 100% Adobe RGB (3840x2160)

NOTE: Resolutions are dependent upon monitor capability, and resolution and color depth settings.

Features

STORAGE AND DRIVES*

Three (3) dedicated drive slots, two (2) M.2 slots, and one (1) 2.5" drive supporting up to 5TB of storage.

Choose up to 2 M.2

SATA SED Solid State Drives*

256 GB SATA Self Encrypting Drive (SED)

HP Z Turbo Drives (NVMe PCIe SSD)

256GB PCIe (NVMe) TLC Solid State Drive

512GB PCIe (NVMe) TLC Solid State Drive

1 TB PCIe (NVMe) TLC Solid State Drive

2 TB PCIe (NVMe) TLC Solid State Drive

256GB PCIe (NVMe) TLC Opal 2 Solid State Drive

512GB PCIe (NVMe) TLC Opal 2 Solid State Drive

NVMe RAID 1*** (optional)

(2) 1 TB PCIe (NVMe) TLC Solid State Drive

(2) 2 TB PCIe (NVMe) TLC Solid State Drive

Choose up to 1 2.5" Storage Bay Drives*,**

256GB SATA SSD

1 TB SATA SSD

*For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30 GB (for Windows 10) is reserved for system recovery software.

** Must be configured with the 4-cell 64Whr battery and no discrete graphics

***RAID 1 Configuration requires 2 NVMe PCIe M.2 drives; both drives must be the same capacity and only available on NVMe technology. Available December 2018

DRIVE CONTROLLERS

M.2 2280 (SATA) SSD:

SATA-3 for SSD

NVMe M.2 2280 SSD:

PCIe Gen 3 x4

RAID 1

PCIe Gen 3 x4*

Supported RAID 0, 1:

SATA M.2 only

NOTE: RAID 1 configuration from HP must be like for like capacity and only available on NVMe technology.

MEMORY

Standard

32 GB DDR4 ECC or 64 GB DDR4 Non-ECC SDRAM (With transfer rates up to 2667MT/s¹)

Two SODIMM slots supporting dual-channel memory

4 GB, 8GB, 16 and 32 GB SODIMMs (for Intel® Core™ or Xeon® Processors)

8GB and 16 GB ECC SODIMMs (for Intel® XEON® Processors)

Maximum

Upgradeable to 64 GB with optional 32 GB SODIMMs in 2 slots

Dual-channel

Features

Maximized dual-channel performance requires SODIMMs of the same size and speed in both memory channels.

NOTE 1: Only 2 DIMM configurations run at 2667 MHz.

NOTE: Maximum memory capacities assume Windows 64-bit operating systems. With Windows 32-bit operating systems, memory above 3 GB may not all be available due to system resource requirements.

Features

NETWORKING/COMMUNICATIONS

Wireless

Support for a broad range of secure, integrated wireless LAN options featuring support for the latest industry standards. Integrated Bluetooth® is also available (factory configurable only) and can be combined with any of the supported wireless LAN options.

802.11 Wireless LAN options**

Intel® Dual Band Wireless-AC 9560 802.11ac (2x2) Wi-Fi® and Bluetooth® 5.0 Combo;
Intel® Dual Band Wireless-AC 9560 802.11ac (2x2) Wi-Fi® and Bluetooth® 5.0 Combo, non-vPro™

Wireless WAN - Mobile Broadband options***, ****

Intel® XMM™ 7360 LTE-Advanced
HP It4132 LTE/HSPA+ 4G Mobile Broadband Module

Near Field Communication¹

NFC: NFC Mirage WNC XRAV-1 (NXP NPC300 I2C 10mmx17mm)

*The term "10/100/1000" or "Gigabit" Ethernet indicates compatibility with IEEE standard 802.3ab for Gigabit Ethernet, and does not connote actual operating speed of 1 Gb/s. For high-speed transmission, connection to a Gigabit Ethernet server and network infrastructure is required.

**Wireless cards are optional or add-on features and requires separately purchased wireless access point and internet service. Availability of public wireless access points limited. The specifications for the 802.11ac WLAN are draft specifications and are not final. If the final specifications differ from the draft specifications, it may affect the ability of the notebook to communicate with other 802.11ac WLAN devices.

***WWAN is an optional feature and requires factory configuration. WWAN use requires separately purchased service contract. Check with service provider for coverage and availability in your area. Connection speeds will vary due to location, environment, network conditions, and other factors. 4G LTE not available on all products, and in all regions.

****WWAN is not available with UHD panels

¹Sold separately or as an optional feature.

AUDIO/MULTIMEDIA

Audio¹

Audio by Bang & Olufsen, dual stereo speakers
Dual array digital microphone
Optional HP World Facing Microphone
Functions keys for volume up and down
Combo microphone/headphone jack
HD audio; featuring HP Noise Cancellation Software, HP Clear Sound Amp and Skype for Business® Certification

Webcam***

720p HD webcam

Optional 720p HD webcam IR camera for face authentication with Windows Hello

- HD format (widescreen)
- Supports videoconferencing and still image capture

Features

- High quality fixed focus lens
- Video capture at various resolutions up to 1280x720 resolution (720p) and up to 30fps
- M-JPEG compression supports higher frame rates for video capture and videoconferencing
- Improved low light sensitivity
- Improved dynamic range

* HD content required to view HD images.

**Optional or add-on feature.

Note 1: Dual-microphone array when equipped with optional webcam and optional world facing microphone

Features

KEYBOARDS/POINTING DEVICES/BUTTONS & FUNCTION KEYS

Keyboard

HP Collaboration Keyboard to manage the most common collaboration function with a keystroke. Backlit keyboard with Function key control to toggle backlit brightness setting - off/full/half brightness

The HP spill-resistant keyboard is designed using a thin layer of Mylar film under the keyboard and a drain system that funnels fluid through a hole in the bottom of the notebook. This minimizes the risk of damage to sensitive components underneath. The 100-key compatible keyboard features a full-pitch key layout with desktop keyboard features, such as editing keys, both left and right control and alt keys, function keys, and 18.7 x 18.4 mm key pitch (center-to-center spacing). U.S. and International key layouts are available. Other features include hot keys for instant access to power conservation and brightness.

Pointing Devices

Clickpad with multi-touch gestures enabled, taps enabled as default

Microsoft Precision Touchpad Default Gestures Support

HP ZBook x360 Pen for G5

Buttons and Function Keys

Discrete buttons provide easy access to the following features:

F1 – Display Switching

F2 – HP SureView (if configured)

F3 - Brightness Down

F4 – Brightness Up

F5 – Audio mute

F6 – Volume down

F7 – Volume up

F8 – Microphone mute

F9 – Keyboard backlight

F10 – NumLock

F11 – Wireless on/off

F12 – Calendar

F13 – Share screen

F14 – Call

F15 – End Call

Features

SOFTWARE AND SECURITY

Workstation ISV Certifications

See the latest list of certifications at: <http://www.hp.com/go/isv>

HP Remote Graphics Software

The remote desktop solution for serious workstation users and their most demanding applications.

Download at: <http://www.hp.com/go/RGS>

HP Performance Advisor

HP Performance Advisor enables optimal configuration of HP Mobile Workstations delivering stability and best performance. HP Performance Advisor will guide your system setup allowing a "custom" configuration that best matches the workstation to user requirements.

Download at: <http://www.hp.com/go/performanceadvisor>

Standard Security Features

HP BIOSphere Gen4¹

HP DriveLock & Automatic DriveLock

BIOS Update via Network

HP BIOS Config Utility (BCU)⁹

Secure Erase³

Absolute persistence module⁷

Pre-boot Authentication

Power-on authentication

SATA 0,1 port disablement (viaBIOS)

RAID configurations

Serial, USB enable/disable (viaBIOS)

Power-on password (viaBIOS)

Setup password (viaBIOS)

Support for chassis padlocks and cable lock devices

HP Sure Click⁴

One-Step Logon

Security lock slot

Support for Intel® AT

TPM 2.0 Embedded Security Chip shipped with Windows 10 (Common Criteria EAL4+ Certified)

Measured Boot

HP Sure Click

HP Sure Start G4²

HP Sure Run⁵

HP Sure Recover⁶

Device Access Manager

HP Security Manager (including Credential Manager and Password Manager¹²)

Windows Defender⁸

HP Host Based Mac Address

HP Client Catalog⁹

HP Driver Packs⁹

HP System Software Manager (SSM)⁹

HP Manageability Integration Kit for Microsoft SCCM¹⁰

TPM

Model: Infineon SLB9670

Version: 7.63.3353.0

Revision: TPM 2.0

FIPS 140-2 Compliant: Yes, with Convert TPM to 2.0 (FIPS 140-2) option

Features

Fingerprint Sensor:

Voltage: 3.0-3.6V

Operating temperature: -20° - 85°C

Imaging current: 31mA

Wake on finger current: 40 uA

Capture rate: 30ms/frame

ESD Resistance: IEC 6100-4-2 4B (+/-15KV)

Detection Matrix 363 dpi, sensing area 8x8 mm

Optional Security Features

HP Fingerprint Sensor (optional)¹¹

IR Camera with Windows Hello

Absolute Data Protect* with GPS Tracking - Subscription based security solution providing the ability to track, initiate physical recovery, conduct asset management, and perform remote data delete by utilizing GPS technology. GPS functionality requires HP Mobile Broadband Module.

* The Absolute Data Protect agent is shipped turned off and must be activated by customers when they purchase a subscription. Subscriptions can be purchased for terms ranging multiple years. Service is limited, check with Absolute for availability outside the U.S.

1. HP BIOSphere Gen4 requires Intel® or AMD 8th generation processors.
2. HP Sure Start Gen4 is available on HP Z Workstations products equipped with 8th generation Intel® or AMD processors.
3. For the methods outlined in the National Institute of Standards and Technology Special Publication 800-88 "Clear" sanitation method.
4. HP Sure Click is available on most HP PCs and supports Microsoft® Internet Explorer and Chromium™. Supported attachments include Microsoft Office (Word, Excel, PowerPoint) and PDF files in read only mode, when Microsoft Office or Adobe Acrobat are installed.
5. HP Sure Run is available on HP Elite products equipped with Intel® or AMD® 8th generation processors
6. HP Sure Recover is available on HP Elite PCs with 8th generation Intel® or AMD processors and requires an open, wired network connection. You must back up important files, data, photos, videos, etc. before using HP Sure Recover to avoid loss of data
7. BIOS Absolute Persistence module is shipped turned off, and will be activated when customers purchase and activate a subscription. Service may be limited. Check with Absolute for availability outside the U.S. The optional subscription service of Absolute Recovery Guarantee is a limited warranty. Certain conditions apply. For full details visit: <http://www.absolute.com/company/legal/agreements/computrace-agreement>. If Data Delete is utilized, the Recovery Guarantee payment is null and void. In order to use the Data Delete service, customers must first sign a Pre-Authorization Agreement and either create a PIN or purchase one or more RSA SecurID tokens from Absolute Software.
8. Windows Defender Opt In, Windows 10, and internet connection required for updates.
9. Not preinstalled, however available for download at <http://www.hp.com/go/clientmanagement>
10. HP Manageability Integration Kit can be downloaded from <http://www8.hp.com/us/en/ads/clientmanagement/overview.html>
11. Finger Sensor is optional
12. HP Password manager requires Windows.

Features

HP CENTRAL MANAGEMENT

HP offers a variety of scalable hardware, software, and BIOS-based security features to help you defend your organization against viruses and other threats. These integrated security features safeguard what matters to you the most - your data, device and identity. Now, be confident your fleet of devices is protected in multiple layers of HP Client Security protection.

HP BIOS Protection keeps you up and running with enhanced protection against virus attacks and other threats. And if the BIOS is accidentally compromised, the auto recovery feature automatically restores it to its fully functional state.

HP Sure Start detects and negates a BIOS attack with automatic recovery of the BIOS even when the installation is accidentally compromised (i.e. power outage). When HP Sure Start heals the BIOS an event log is generated that an IT administrator can retrieve so the business is aware of a BIOS attack. Golden copy of BIOS is stored in protected nonvolatile memory providing redundant, hardware-based protection against a new generation of attacks. This helps to future-proof your technology and business.

An optional fingerprint sensor helps keep your identity secure. The security cable slot helps keep your notebook physically secure.

You can even permanently destroy data on your hard drive in preparation for your system disposal or redeployment with Secure Erase.

System Technical Specifications

POWER

Power Supply

HP 150W Slim Smart AC adapter
(153 x 66 x 22 mm)

Primary Battery

HP Long Life 4-cell Polymer Battery (64 WHr) *

HP Long Life 6-cell Polymer Battery (96 WHr) *

NOTE: Battery is internal and not replaceable by the customer

NOTE: HP Long Life 4-cell 64WHr battery can be configured with a hard disk drive and cannot be configured with discrete graphics. HP Long Life 6-cell 96 WHr battery cannot be configured with a hard disk drive and is required in discrete graphics configurations.

Battery Life

Battery life up to 18.5 hours for UMA graphics only configuration**

Battery life up to 16.5 hours for Hybrid graphics configuration**

System Standby Time

Up to 1.4 weeks***

* Available with 3-year limited warranty only

** Battery life will vary depending on the product model, configuration, loaded applications, features, use, wireless functionality and power management settings. The maximum capacity of the battery will naturally decrease with time and usage. See MobileMark14 battery benchmark <https://bapco.com/products/mobilemark-2014/> for additional details.

*** Standby life will vary depending on various factors including battery, Memory, CPU, EC and LAN chip. The maximum capacity of the battery will naturally decrease with time and usage.

Power Conservation

NVIDIA® Optimus or AMD Enduro™ technology

Hibernation

Standby

ACPI compliance

ENVIRONMENTAL

US ENERGY STAR®

IT ECO declaration

EPEAT® registered*

Low Halogen**

* EPEAT® registered where applicable. EPEAT registration varies by country. See www.epeat.net for registration status by country. See HP's 3rd party option store for solar energy accessory www.hp.com/go/options.

**External power supplies, power cords, cables and peripherals are not low halogen. Service parts obtained after purchase may not be low halogen.

System Technical Specifications

WEIGHTS & DIMENSIONS

Weight

Starting at 4.9 lb. (2.22kg.)

Dimensions (w x d x h)

14.17 in x 9.65 in x 0.35 in (front) – 0.74 in (rear)

360 mm x 254 mm x 8.8 mm (front) – 18.7 mm (rear)

Note: Height varies depending upon where on the notebook the measurement is made. Weight varies by configuration and components. Weight includes Quad Core CPU, UHD, 4-cell battery, Intel® UHD graphics, no FPR, 8GB x 1 SODIMM, WLAN, M.2 SSD, no camera, no WWAN, no BT.

PORTS/SLOTS

Ports

Left side:

- (1) USB 3.0 Charging Port
- (1) USB 3.0
- (1) Security lock slot

Right side:

- (1) HDMI 2.0
- (2) Thunderbolt™ 3* (Supporting DisplayPort™ 1.3, USB 3.1 Gen2, PCIe Gen 3 devices)
- (1) Stereo microphone in / headphone-out combo jack
- (1) Power Connector
- (1) Full-size SD Card Reader

Thunderbolt™ 3

Thunderbolt™3 ports supports DisplayPort™ 1.3, USB 3.1 Gen 2, and PCIe Gen 3 devices over the new USB-C port connector. The port is compatible with existing DisplayPort™ displays, devices, and cables. Install all the latest drivers for your Thunderbolt™ device before connecting the device to the Thunderbolt™ port. Thunderbolt™ cable and Thunderbolt™ device (sold separately) must be compatible with Windows®. To determine whether your device is Thunderbolt™ Certified for Windows, see <https://thunderbolttechnology.net/products>.

Digital Media Slots

- (1) SD UHS-II Flash Media slot (Supports next generation SD (Secure Digital), backward compatible to SDHC, SDXC,

SERVICE AND SUPPORT

Limited 3-year or 1-year limited warranty options available, depending on country. Batteries have a default one-year limited warranty except for Long Life batteries which will have same 1-year or 3-year limited warranty as the platform. Optional* HP Care Pack Services are extended service contracts which go beyond your standard limited warranties. To choose the right level of service for your HP product, use the HP Care Pack Services Lookup Tool at <http://www.hp.com/go/cpc>.

*Sold separately or as an optional feature. Service levels and response times for HP Care Packs may vary depending on your geographic location. Service starts on date of hardware purchase. Restrictions and limitations apply. HP services are governed by the applicable HP terms and conditions of service provided or indicated to Customer at the time of purchase. Customer may have additional statutory rights according to applicable local laws, and such rights are not in any way affected by the HP terms and conditions of service or the HP Limited Warranty provided with your HP Product. Consult your local HP Customer Support Center for details.

System Technical Specifications

SYSTEM UNIT

Stand-Alone Power Requirements (AC Power)	Nominal Operating Voltage	19.5 V	
	Average Operating Power	DreamColor Without DreamColor	Average Operating Power
	Max Operating Power	< 200 W	
Temperature	Operating	32° to 95° F (0° to 35° C)	
	Non-operating	-4° to 140° F (-20° to 60° C)	
Relative Humidity	Operating	10% to 90%, non-condensing	
	Non-operating	5% to 95%, 101.6° F (38.7° C) maximum wet bulb temperature	
Shock	Operating	40 G, 2 ms, half-sine	
	Non-operating	200 G, 2 ms, half-sine	
Random Vibration	Operating	0.75 grms	
	Non-operating	1.50 grms	
Altitude (unpressurized)	Operating	-50 to 10,000 ft (-15.24 to 3,048 m)	
	Non-operating	-50 to 40,000 ft (-15.24 to 12,192 m)	
Industry Standard Certifications	UL	Yes	
	CSA	Yes	
	FCC Compliance	Yes, Class B	
	ENERGY STAR®	Select models*	
	EPEAT®	Gold **	
	ICES	Complete	
	Australia / NZ A-Tick Compliance	Complete	
	CCC	Complete	
	Japan VCCI Compliance	Complete	
	KC	Complete	
	BSMI	Complete	
	CE Marking Compliance	Complete	
	MIL STD 810G	Complete ***	

* Configurations of the HP ZBook Studio that are ENERGY STAR® qualified are identified as HP ZBook Studio G5 ENERGY STAR® on HP websites and on <http://www.energystar.gov>.

** EPEAT® registered where applicable. EPEAT registration varies by country. See <http://www.epeat.net> for registration status by country. See HP's 3rd party option store for solar energy accessory www.hp.com/go/options.

*** MIL STD 810G testing is pending and is not intended to demonstrate fitness for U.S. Department of Defense contract requirements or for military use. Test results are not a guarantee of future performance under these test conditions. Accidental damage requires an optional HP Accidental Damage Protection Care Pack.

For accessibility information on HP products, please visit: <http://www.hp.com/accessibility>.

Technical Specifications – Displays

DISPLAYS

15.6" diagonal FHD LED IPS, Touch, with Ambient light sensor 100% sRGB (1920x1080) (400 nits)	Active Area (W x H)	344.16 x 193.59
	Dimensions (W x H)	350.96 x 216.75
	Weight	370 g (max)
	Touch enabled	Yes; Corning® Gorilla® Glass 4
	Contrast Ratio	600:1 (typical)
	Refresh Rate	60 Hz
	Brightness*	400 nits (typical)
	Pixel Resolution	Format 1920 x 1080 (FHD)
		Configuration RGB Stripe
	Backlight	LED
	PPI	141
	Viewing Angle	85/85/85/85 (Left/Right/Down/Up) (typical)

* All specifications represent the typical specifications provided by HP's component manufacturers; actual performance may vary either higher or lower.

15.6" diagonal UHD LED IPS, Touch, with Ambient light sensor 100% sRGB (3840x2160) (400 nits)	Active Area (W x H)	344.2176 x 193.62
	Dimensions (W x H)	350.96 x 216.95
	Diagonal Size	15.6 in (39.6 cm)
	Weight	320 g (max)
	Touch enabled	Yes; Corning® Gorilla® Glass 4
	Contrast Ratio	1200:1 (typical)
	Refresh Rate	60 Hz
	Brightness*	400 nits (typical)
	Pixel Resolution	Format 1920 x 1080 (FHD)
		Configuration RGB Stripe
	Backlight	LED
	PPI	282
	Viewing Angle	85/85/85/85 (Left/Right/Down/Up) (typical)

* All specifications represent the typical specifications provided by HP's component manufacturers; actual performance may vary either higher or lower.

HP Dream Color Display 15.6" diagonal UHD LED IPS - 10 (8+2) bit color, Anti-glare Touch (3840x2160) (600 nits) 100% Adobe RGB	Active Area (W x H)	344.2176 x 193.62
	Dimensions (W x H)	350.96 x 217.45
	Diagonal Size	15.6 in (39.6 cm)
	Weight	380 g (max)
	Surface Treatment	Anti-glare
	Touch enabled	Yes; Corning® Gorilla® Glass 4
	Contrast Ratio	1200:1 (typical)
	Refresh Rate	60 Hz

Technical Specifications – Displays

Brightness*	600 nits (typical)
Pixel Resolution	Format 3840 x 2160 (UHD)
	Configuration RGB Stripe
Backlight	RG phosphors + Backlit-LED
PPI	282
Viewing Angle	85/85/85/85 (Left/Right/Down/Up) (typical)

HP Dream Color Display 15.6" diagonal UHD LED IPS - 10 (8+2) bit color, Touch (3840x2160) (600 nits) 100% Adobe RGB

Active Area (W x H)	344.2176 x 193.62
Dimensions (W x H)	350.96 x 217.45
Diagonal Size	15.6 in (39.6 cm)
Weight	380 g (max)
Touch enabled	Yes; Corning® Gorilla Glass® 4
Contrast Ratio	1200:1 (typical)
Refresh Rate	60 Hz
Brightness*	600 nits (typical)
Pixel Resolution	Format 3840 x 2160 (UHD)
	Configuration RGB Stripe
Backlight	RG phosphors + Backlit-LED
PPI	282
Viewing Angle	85/85/85/85 (Left/Right/Down/Up) (typical)

HP Sure View Privacy Display 15.6" diagonal FHD LED IPS, Touch, 100% sRGB (1920x1080) (650 nits)

Dimensions (W x H)	350.96 x 216.75
Diagonal Size	15.6 in (39.6 cm)
Weight	320 g (max)
Touch enabled	Yes; Corning® Gorilla® Glass 4
Contrast Ratio	600:1 (typical)
Refresh Rate	120 Hz
Brightness*	650 nits (typical)
Pixel Resolution	Pitch 0.1793 x 0.1793 mm
	Format 1920 X 1080 (FHD)
	Configuration RGB Stripe
Backlight	LED
PPI	141
Viewing Angle	85/85/85/85 (Left/Right/Down/Up) (typical)

* All specifications represent the typical specifications provided by HP's component manufacturers; actual performance may vary either higher or lower.

Technical Specifications – Storage and Drives

STORAGE AND DRIVES

Internal Storage

256 GB SATA TLC Solid State Drive (2.5")	Drive Weight	0.17 lb (78 g)	
	Capacity	256 GB	
	Height	0.28 in (7 mm)	
	Width	2.75 in (69.85 mm)	
	Interface	ATA-8, SATA 3.0	
	NAND Type	TLC	
	Form-Factor (I/O)	2.5 inch	
	Performance	Maximum Sequential Read	Maximum Sequential Write
		530 MB/s ~ 560 MB/s	500 MB/s ~ 525 MB/s
	Logical Blocks	500,118,192	
Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]		
Features	ATA Security; DIPM; TRIM; DEVSLP		

1 TB SATA TLC Solid State Drive (2.5")	Drive Weight	0.17 lb (78 g)	
	Capacity	1 TB	
	Height	0.28 in (7 mm)	
	Width	2.75 in (69.85 mm)	
	Interface	ATA-8, SATA 3.0	
	NAND Type	TLC	
	Form-Factor (I/O)	2.5 inch	
	Performance	Maximum Sequential Read	Maximum Sequential Write
		530 MB/s ~ 560 MB/s	500 MB/s ~ 530 MB/s
	Logical Blocks	2,000,409,264	
Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]		
Features	ATA Security; DIPM; TRIM; DEVSLP		

256 GB M.2 Self-Encrypting Drive TLC Solid State Drive	Drive Weight	0.02 lb (<10 g)	
	Capacity	256 GB	
	Height	0.09 in (2.3 mm)	
	Width	0.87 in (22 mm)	
	Interface	ATA-8, SATA 3.0	
	NAND Type	TLC	
	Form-Factor (I/O)	M.2 2280	
	Performance	Maximum Sequential Read	Maximum Sequential Write
		530 MB/s ~ 560 MB/s	500 MB/s ~ 530 MB/s
	Logical Blocks	500,118,192	
Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]		
Features	ATA Security; TCG Opal 2.0, DIPM; TRIM; DEVSLP		

Technical Specifications – Storage and Drives

256 GB M.2 NVMe TLC Solid State Drive	Drive Weight	0.02 lb (<10 g)		
	Capacity	256 GB		
	Height	0.09 in (2.3 mm)		
	Width	0.87 in (22 mm)		
	Generation	Samsung PM961/ Toshiba XG5		
	NAND Type	TLC		
	Form-Factor (I/O)	M.2 2280		
	Interface	PCIe NVMe Gen3X4		
	Performance	Maximum Sequential Read	Maximum Sequential Write	
		2580 MB/s ~ 2600 MB/s	1000 MB/s ~ 1100 MB/s	
	Logical Blocks	500,118,192		
	Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]		
	Features	ATA Security (Option), TRIM; L1.2		

256 GB M.2 NVMe TLC SED Solid State Drive	Drive Weight	0.02 lb (<10 g)		
	Capacity	256 GB		
	Height	0.09 in (2.3 mm)		
	Width	0.87 in (22 mm)		
	Generation	Samsung PM961 SED Opal2/ Toshiba XG5 SED Opal2		
	NAND Type	TLC		
	Form-Factor (I/O)	M.2 2280		
	Interface	PCIe NVMe Gen3X4		
	Performance	Maximum Sequential Read	Maximum Sequential Write	
		2580 MB/s ~ 2600 MB/s	Up to 1000 MB/s	
	Logical Blocks	500,118,192		
	Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]		
	Features	ATA Security (Option); TCG Opal 2.0; TRIM; L1.2		

512 GB M.2 NVMe TLC Solid State Drive	Drive Weight	0.02 lb (<10 g)		
	Capacity	512 GB		
	Height	0.09 in (2.3 mm)		
	Width	0.87 in (22 mm)		
	Generation	Samsung PM981 / Toshiba XG5		
	NAND Type	TLC		
	Form-Factor (I/O)	M.2 2280		
	Interface	PCIe NVMe Gen3X4		
	Performance	Maximum Sequential Read	Maximum Sequential Write	
		2800 MB/s ~ 2900 MB/s	1000 MB/s ~ 1800 MB/s	
	Logical Blocks	1,000,215,215		

Technical Specifications – Storage and Drives

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]
Features ATA Security, TRIM; L1.2

512 GB M.2 NVMe TLC Solid State Drive

Drive Weight 0.02 lb (<10 g)
Capacity 512 GB
Height 0.09 in (2.3 mm)
Width 0.87 in (22 mm)
Generation Samsung PM981 SED Opal2/ Toshiba XG5 SED Opal2
NAND Type TLC
Form-Factor (I/O) M.2 2280
Interface PCIe NVMe Gen3X4
Performance **Maximum Sequential Read** 2800 MB/s ~ 2900 MB/s **Maximum Sequential Write** 1000 MB/s ~ 1800 MB/s
Logical Blocks 1,000,215,215
Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]
Features ATA Security (Option); TCG Opal 2.0 ; TRIM; L1.2

1 TB, M.2 NVMe TLC Solid State Drive

Drive Weight 0.02 lb (<10 g)
Capacity 1 TB
Height 0.09 in (2.3 mm)
Width 0.87 in (22 mm)
Generation Samsung PM981 / Toshiba XG5
NAND Type TLC
Form-Factor (I/O) M.2 2280
Interface PCIe NVMe Gen3X4
Performance **Maximum Sequential Read** 2900 MB/s ~ 3000 MB/s **Maximum Sequential Write** Up to 2000MB/s
Logical Blocks 2,000,409,264
Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]
Features ATA Security, TRIM; L1.2
Available in RAID 1 config** Yes

2 TB, M.2 NVMe TLC Solid State Drive

Drive Weight 0.02 lb (<10 g)
Capacity 2 TB
Height 0.09 in (2.3 mm)
Width 0.87 in (22 mm)
Generation Toshiba XG5P
NAND Type TLC
Form-Factor (I/O) M.2 2280
Interface PCIe NVMe Gen3X4

Technical Specifications – Storage and Drives

Performance	Maximum Sequential Read	Maximum Sequential Write
	Up to 2900MB/s	Up to 2100 MB/s
Logical Blocks	3,907,029,168	
Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]	
Features	ATA Security, TRIM; L1.2	
Available in RAID 1** config	Yes	

*For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30 GB (for Windows® 10) disk is reserved for system recovery software.

** RAID 1 Configuration requires 2 NVMe PCIe M.2 drives; both drives must be the same capacity and only available on NVMe technology. Available December 2018

Technical Specifications – Networking/Communications

NETWORKING/COMMUNICATIONS

<p>Intel® Dual Band Wireless-N 9560AC 802.11 a/b/g/n (2x2) WiFi + Bluetooth 5.0 Combo Adaptor*</p>	<p>Wireless LAN Standards</p>	<p>IEEE 802.11a IEEE 802.11b IEEE 802.11g IEEE 802.11n IEEE 802.11ac</p>
	<p>Interoperability</p>	<p>Wi-Fi certified</p>
	<p>Frequency Band</p>	<p>802.11b/g/n 2.402 - 2.482 GHz Note: The FCC has declared as of January 1, 2015 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.</p> <p>802.11a/n 4.9 - 4.95 GHz (Japan) 5.15 - 5.25 GHz 5.25 - 5.35 GHz 5.47 - 5.725 GHz 5.825 - 5.850 GHz Note: No support for this band in Indonesia</p>
	<p>Data Rates</p>	<p>802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps 802.11b: 1, 2, 5.5, 11 Mbps 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps 802.11n: MCS 0 ~ MCS 15 (20MHz and 40MHz) 802.11ac : MCS0 ~ MCS9, (1SS, and 2SS) (20MHz, 40MHz, and 80MHz)</p>
	<p>Modulation</p>	<p>Direct Sequence Spread Spectrum CCK, BPSK, QPSK, 16-QAM, 64-QAM, 256-QAM</p>
	<p>Security¹</p>	<ul style="list-style-type: none"> • IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only • AES-CCMP: 128 bit in hardware • 802.1x authentication • WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES. • WPA2 certification • IEEE 802.11i • Cisco Certified Extensions, all versions through CCX4 and CCX Lite • WAPI
	<p>Network Architecture Models</p>	<p>Ad-hoc (Peer to Peer) Infrastructure (Access Point Required)</p>
	<p>Roaming</p>	<p>IEEE 802.11 compliant roaming between band Access Points</p>
	<p>Output Power²</p>	<p>802.11b : +16dBm minimum 802.11g : +14dBm minimum 802.11a : +14dBm minimum 802.11n HT20(2.4GHz) : +14dBm minimum 802.11n HT40(2.4GHz) : +12dBm minimum 802.11n HT20(5GHz) : +14dBm minimum 802.11n HT40(5GHz) : +12dBm minimum</p>
	<p>Power Consumption</p>	<p>Transmit: 2.0 Watts Receive: 1.6 Watts Idle mode: 180 mW (WLAN Associated)</p>

Technical Specifications – Networking/Communications

	Idle mode: 50 mW (WLAN unassociated) Connect Standby: 10 mW (WLAN+BT) Radio disabled: 5 mW
Power Management	ACPI and PCI Express compliant power management 802.11 compliant power saving mode
Receiver Sensitivity³	802.11b, 1Mbps : -94dBm maximum 802.11b, 11Mbps : -86dBm maximum 802.11g, 6Mbps : -88dBm maximum 802.11g, 54Mbps : -74dBm maximum 802.11a, 6Mbps : -88dBm maximum 802.11a, 54Mbps : -74dBm maximum 802.11n, MCS07 : -69dBm maximum 802.11n, MCS15 : -66dBm maximum 802.11ac, 1SS, MCS-0 : -86dBm maximum 802.11ac, 1SS, MCS-9 : -61dBm maximum 802.11ac, 2SS, MCS-0 : -83dBm maximum 802.11ac, 2SS, MCS-9 : -58dBm maximum
Antenna Type	High efficiency antenna with spatial diversity, mounted in the display enclosure Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications
Form Factor	PCI-Express M.2 MiniCard
Dimensions	Type 2230 : 2.3 x 22.0 x 30.0 mm Or Type 1630 : 2.3 x 16.0 x 30.0 mm
Weight	Type 2230 : 2.8g Or Type 1630 : 2g
Operating Voltage	3.3v +/- 9%
Temperature	Operating 14° to 158° F (-10° to 70° C) Non-operating -40° to 176° F (-40° to 80° C)
Humidity	Operating 10% to 90% (non-condensing) Non-operating 5% to 95% (non-condensing)
Altitude	Operating 0 to 10,000 ft (3,048 m) Non-operating 0 to 50,000 ft (15,240 m)
LED Activity	LED Amber - Radio OFF; LED White - Radio ON

1. Check latest software/driver release for updates on supported security features.
2. Maximum output power may vary by country according to local regulations.
3. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

* Wireless access point and internet service required. Availability of public wireless access points limited.

HP Integrated Module with Bluetooth 4.2 Wireless Technology

Bluetooth Specification	4.2 Compliant
Frequency Band	2402 to 2480 MHz
Number of Available Channels	Legacy : 0~79 (1 MHz/CH) BLE : 0~39 (2 MHz/CH)
Data Rates and Throughput	Legacy : 3 Mbps data rate; throughput up to 2.17 Mbps BLE : 1 Mbps data rate; throughput up to 0.2 Mbps

Technical Specifications – Networking/Communications

Transmit Power	Legacy : Synchronous Connection Oriented links up to 3, 64 kbps, voice channels												
Receiver Sensitivity	Legacy : Asynchronous Connection Less links 2178.1 kbps/177.1 kbps asymmetric (3-DH5) or 864 kbps symmetric (3-EV5) The Bluetooth component shall operate as a Class II Bluetooth device with a maximum transmit power of + 4 dBm for BR and EDR.												
Power Consumption	<table border="1"> <thead> <tr> <th>Modulation</th> <th>0.01% BER</th> <th>0.001% BER</th> </tr> </thead> <tbody> <tr> <td>GFSK</td> <td>-80 dBm</td> <td>-70 dBm</td> </tr> <tr> <td>$\pi/4$-DQPSK</td> <td>-80 dBm</td> <td>-70 dBm</td> </tr> <tr> <td>8DPSK</td> <td>-80 dBm</td> <td>-70 dBm</td> </tr> </tbody> </table>	Modulation	0.01% BER	0.001% BER	GFSK	-80 dBm	-70 dBm	$\pi/4$ -DQPSK	-80 dBm	-70 dBm	8DPSK	-80 dBm	-70 dBm
Modulation	0.01% BER	0.001% BER											
GFSK	-80 dBm	-70 dBm											
$\pi/4$ -DQPSK	-80 dBm	-70 dBm											
8DPSK	-80 dBm	-70 dBm											
Range	Peak (Tx) 330 mW Peak (Rx) 230 mW Selective Suspend 17 mW Legacy Up to 33 ft (10 m) BLE Up to 99 ft (30 m)												
Electrical Interface	USB 2.0 compliant												
Bluetooth Software Supported	Microsoft Windows® Bluetooth Software												
Link Topology	Point to Point, Multipoint Pico Nets up to 7 slaves												
Security	Full support of Bluetooth Security Provisions												
Power Management	Microsoft Windows® ACPI, and USB Bus Support Self-configurable to optimize power conservation in all operating modes, including Standby, Hold, Park, and Sniff												
Certifications	All necessary regulatory approvals for supported countries, including: FCC (47 CFR) Part 15C, Section 15.247 & 15.249 ETS 300 328, ETS 300 826 Low Voltage Directive IEC950 UL, CSA, and CE Mark												
Bluetooth Profiles Supported	Serial Port Profile (SPP) Service Discovery Application Profile (SDAP) Dial-Up Networking (DUN) Generic Object Exchange Profile (GOEP) Object Push Profile (OPP) Hard Copy Cable Replacement (HCRP) Personal Area Networking Profile (PAN) Human Interface Device Profile (HID) Hands Free Profile (HFP) Advanced Audio Distribution Profile (A2DP) Audio Video Remote Control Profile (AVRCP)												

HP It4132 LTE/HSPA+ 4G Mobile Broadband Module

Technology/Operating bands	LTE: 2100 (Band 1), 1900 (Band 2), 1800 (Band 3) MHz, 850 (Band 5), 2600 (Band 7), 900 (Band 8) MHz, 800 (Band 20), 700 (Band 28) MHz. HSPA+: 2100 (Band 1), 1900 (Band 2), 850 (Band 5), 900 (Band 8) MHz E-GPRS: 1900 (Band 2), 1800 (Band 3), 850 (Band 5), 900 (Band 8) MHz
Wireless protocol standards	3GPP Release 10 LTE Specification CAT.4, 20MHz BW WCDMA R99, 3GPP Release 5, 6, 7 and 8 UMTS Specification

Technical Specifications – Networking/Communications

	E-GPRS: Class B, Multi-slot class 12, coding schemes CS1 - CS4 and MSC1 - MSC9
GPS	Standalone, A-GPS (MS-B and LTO)
GPS bands	1575.42 MHz ± 1.023 MHz, GLONASS 1596-1607MHz
Maximum data rates	LTE: 150 Mbps (Download), 50 Mbps (Upload) DC-HSPA+: 42 Mbps (Download), 5.76 Mbps (Upload) HSPA+: 21Mbps (Download), 5.76 Mbps (Upload) EDGE: 236.8 kbps (Download), 236.8 kbps (Upload) GPRS: 85.6 kbps(Download), 85.6 kbps (Upload)
Maximum output power	LTE: 23 dBm HSPA+: 23.5 dBm E-GPRS 1900/1800: 26 dBm E-GPRS 900/850: 27 dBm GPRS 1900/1800: 29.5 dBm GPRS 900/850: 32.5 dBm
Maximum power consumption	LTE: 1,200 mA (peak); 900 mA (average) HSPA+: 1,100 mA (peak); 800 mA (average) E-GPRS: 2,600 mA (peak); 500 mA (average)
Form Factor	M.2, 3042-S3 Key B
Weight	6 g
Dimensions (Length x Width x Thickness)	42 x 30 x 2.3 mm

* Mobile Broadband is an optional feature. Connection requires wireless data service contract, network support, and is not available in all areas. Contact service provider to determine the coverage area and availability. Connection speeds will vary due to location, environment, network conditions, and other factors. 4G LTE not available on all products or in all countries.

Intel® XMM™ 7360 LTE-Advanced	Technology/Operating Bands	FDD LTE: 2100 (Band 1), 1900 (Band 2), 1800 (Band 3), 1700/2100 (Band 4), 850 (Band 5), 2600 (Band 7), 900 (Band 8), 1400 (Band 11), 700 (Band 12 lower), 700 (Band 13 upper), 700 (Band 17 lower), 850 (Band 18 lower), 850 (Band 19 upper), 800 (Band 20), 1400 (Band 21), 850 (Band 26), 700 (Band 28), 700 (Band 29 RX only), 2300 (Band 30), 2100 (Band 66). TDD LTE: 2600 (Band 38), 1900 (Band 39), 2400 (Band 40), 2500 (Band 41). HSPA+: 2100 (Band 1), 1900 (Band 2), 1700/2100 (Band 4), 850 (Band 5), 900 (Band 8) MHz
	Wireless Protocol Standards	3GPP Release 11 LTE Specification CAT.9, DL 60MHz BW throughput up to 450Mbps; UL 20MHz throughput up to 50Mbps WCDMA R99, 3GPP Release 5, 6, 7 and 8 UMTS Specification
	GPS	Standalone, A-GPS (MS-A, MS-B and XTRA)
	GPS Bands	1575.42 MHz ± 1.023 MHz, GLONASS 1596-1607MHz, Beidou 1561.098 MHz
	Maximum Data Rates	LTE: 450 Mbps (Download), 50 Mbps (Upload) DC-HSPA+: 42 Mbps (Download), 5.76 Mbps (Upload) HSPA+: 21Mbps (Download), 5.76 Mbps (Upload)
	Maximum Output Power	LTE: 23 dBm HSPA+: 23.5 dBm
	Maximum Power Consumption	LTE: 1,200 mA (peak); 900 mA (average) HSPA+: 1,100 mA (peak); 800 mA (average)
	Form Factor	M.2, 3042-S3 Key B
	Weight	5.8g
	Dimensions	1.65 x 1.18 x 0.09 in (42 x 30 x 2.3 mm)

Technical Specifications – Networking/Communications

(Length x Width x
Thickness)

* Mobile Broadband is an optional feature. Connection requires wireless data service contract, network support, and is not available in all areas. Contact service provider to determine the coverage area and availability. Connection speeds will vary due to location, environment, network conditions, and other factors. 4G LTE not available on all products or in all countries.

Technical Specifications – Audio/Multimedia

AUDIO/MULTIMEDIA – BANG & OLUFSEN

Hardware	Implementation	Synaptics CX8400 with two NXP TFA9891 discrete smart amplifiers
	Function Key	Volume up, volume down, and mute
	Volume Controls	
	Full Duplex	Yes
	Microphone In	Stereo
	Headphone/Line Out	Stereo
	Integrated Microphone	Yes, (1) dual-array digital microphone and (1) HP World Facing Microphone when equipped with optional webcam
Audio Output Quality	Frequency Response	20 Hz - 20 kHz
	Signal to Noise Ratio	106dB (DAC), 102dB (ADC)
	Total Harmonic Distortion	91dB THD+n on LineOut/HP (0.003%)
	Noise Floor	-110 dB
	Play Sampling Rate(s)	Up to 192kHz
	Record Sampling Rate(s)	Up to 96kHz
	DAC	16, 20 or 24-bit
	ADC	16, 20 or 24-bit
Internal Stereo Speaker	Power Rating	1 Watt/per top speaker 2 Watt/per bottom speaker
	Impedance	8 ohms/per top speaker 4 ohms/per bottom speaker

HP ZBook Rechargeable Active Pen	Dimensions (L x W)	D: 10.2mm L: 148mm
	Weight	0.53 oz (15 g) Pen only
	Tip Diameter	1.8 mm
	Tip Length	2.7 mm
	Power	Rechargeable battery Charge time: approximately 30 minutes. Life per charge: up to 7 days of normal use.
	Buttons	Yes, 3
	LED indicator	Battery and pairing status
	Pen pressure level resolution	4096 levels
	Tilt Operation	Yes
	Palm Rejection	Yes
	Hover Reading Heights	> 5 mm
	System requirements	Windows 8, Windows 8.1, Windows 10
	Kit contents	HP Active Pen, USB-A to USB-C Charging cable, replacement nibs (4 POM and 6 Elastomer), replacement tip tool and documentation
	Functionality	Right-click, draw, type, and navigate better than ever with a capacitive tip that offers pin-point accuracy to help improve productivity. Bluetooth button support quick application launch, screenshot capture, and Cortana speaker. Pen supports hover feature, pressure sensitivity levels up to 4096, and tilt function to enable excellent inking experience.

Technical Specifications – Audio/Multimedia

Soft tip for quiet performance and provides pen-on-paper inking experience.
Equipped USB-C fast charging with 30 mins charging for one-week battery life.

**Color
Compatibility**

Black
HP ZBook Studio x360 G5

Technical Specifications – Power

POWER

HP 150W Slim Smart AC Adapter	Dimensions	6.02 x 2.60 x .87 in ((153 x 66 x 22 mm)	
	Weight	0.71 lbs (320 g)	
	Input	100 to 240 VAC	
		Input Efficiency	88% min at 115 VAC
		Input frequency range	47 to 63 Hz
		Input AC current	2.9 A at 90 VAC, 1.45 A at 180 VAC
	Output	Output power	150W
		DC output	19.5V
		Hold-up time	5 msec at 115 VAC input
		Output current limit	<16A, Over voltage protection- 29V max automatic shutdown
		Connector	3 pin/grounded, mates with interchangeable cords
	Environmental Design	Operating temperature	32° to 104° F (0° to 40° C)
		Non-operating (storage) temperature	-4° to 149° F (-20° to 65° C)
		Altitude	0 to 10,000 ft (0 to 3,048 m)
		Humidity	20% to 80%
Storage Humidity		10% to 90%	
EMI and Safety Certifications	CE Mark- full compliance with LVD and EMC directives; Worldwide safety standards- IEC950, EN60950, UL1950, Class 1, SELV; Agency approvals- C-UL-US, NORDICS, DENAN, EN55022 Class B, FCC Class B, CISPR22 Class B, CCIB, NOM-1 NYCE; MTBF- over 200,000 hours at 25°C ambient condition.		

HP Long Life 4-cell Polymer Battery (64 WHr)	Dimensions (H x W x L)	7.9 x 3.49 x 0.32 in (20.08 x 8.86 x 0.81cm)	
	Weight (max)	0.619lb (281g)	
	Cells/Type	4-cell; Polymer	
	Energy	Voltage	15.4V
		Amp-hour capacity	4.155Ah
		Watt-hour capacity	64Wh
	Temperature	Operating (Charging)	32° to 113° F (0° to 45° C)
		Operating (Discharging)	14° to 140° F (-10° to 60° C)
		Non-operating	-4° to 140° F (-20° to 60° C)
	Battery Re-Charge Time	System in OFF or Standby Mode	3 hours
System ON		3 to 5 hours	
Fuel Gauge LED	No		
Warranty*	3 year		

* 3-year platform warranty is required for a 3-year Long Life Battery warranty.

Dimensions (H x W x L) 13.02 x 3.51 x 0.319 in (33.08 x 8.92 x 0.81cm)

Technical Specifications – Power

HP Long Life 6-cell Polymer Battery (96 WHr)	Weight (max)	1.12lb (420g)		
	Cells/Type	6-cell; Polymer		
	Energy	Voltage	11.55V	
		Amp-hour capacity	8.31Ah	
		Watt-hour capacity	95Wh	
	Temperature	Operating (Charging)	32° to 122°F (0° to 50° C)	
		Operating (Discharging)	14° to 140°F (-10° to 60° C)	
		Non-operating	>140° F (>60° C)	
	Battery Re-Charge Time	System in OFF or Standby Mode	3 hours	
		System ON	3 to 5 hours	
	Fuel Gauge LED	No LED		
Warranty*	3 year			

* 3-year platform warranty is required for a 3-year Long Life Battery warranty.

Technical Specifications – Environmental

ENVIRONMENTAL DATA

Eco-Label Certifications & declarations

This product has received or is in the process of being certified to the following approvals and may be labeled with one or more of these marks:

- IT ECO declaration
- US ENERGY STAR®
- US Federal Energy Management Program (FEMP)
- EPEAT® GOLD registered in the United States. See <http://www.epeat.net> for registration status in your country.

System Configuration

The configuration used for the Energy Consumption and Declared Noise Emissions data for the Notebook model is based on a “Typically Configured Notebook”.

Energy Consumption (in accordance with US ENERGY STAR® test method)

	115VAC, 60Hz	230VAC, 50Hz	100VAC, 50Hz
Normal Operation (Sort idle)	11.20 W	10.51 W	11.24 W
Normal Operation (Long idle)	6.70 W	6.30 W	6.37 W
Sleep	1.13 W	1.12 W	1.14 W
Off	0.41 W	0.43 W	0.42 W

Note:

Energy efficiency data listed is for an ENERGY STAR® compliant product if offered within the model family. HP computers marked with the ENERGY STAR® Logo are compliant with the applicable U.S. Environmental Protection Agency (EPA) ENERGY STAR® specifications for computers. If a model family does not offer ENERGY STAR® compliant configurations, then energy efficiency data listed is for a typically configured PC featuring a hard disk drive, a high efficiency power supply, and a Microsoft Windows® operating system.

Heat Dissipation*

	115VAC, 60Hz	230VAC, 50Hz	100VAC, 50Hz
Normal Operation (Short idle)	38 BTU/hr	36 BTU/hr	38 BTU/hr
Normal Operation (Long idle)	23 BTU/hr	22 BTU/hr	22 BTU/hr
Sleep	4 BTU/hr	4 BTU/hr	4 BTU/hr
Off	1.4 BTU/hr	1 BTU/hr	1 BTU/hr

*NOTE: Heat dissipation is calculated based on the measured watts, assuming the service level is attained for one hour.

Declared Noise Emissions (in accordance with ISO 7779 and ISO 9296)

	Sound Power (L _{WAd} , bels)	Sound Pressure (L _{pAm} , decibels)
Typically Configured – Idle	3.2	22
Fixed Disk – Random writes	3.2	21

Longevity and Upgrading

This product can be upgraded, possibly extending its useful life by several years. Upgradeable features and/or components contained in the product may include:

- 2 USB ports
- 2 Thunderbolt™ 3 ports
- 1 2.5" Storage Bay Drive
- 2 M.2 SATA SED Solid State Drives

Technical Specifications – Environmental

- 2 SODIMM memory slots
- 1 HDMI 2.0 port

Spare parts are available throughout the warranty period and or for up to “5” years after the end of production.

Batteries

This battery(s) in this product comply with EU Directive 2006/66/EC

Batteries used in the product do not contain:

- Mercury greater than 1ppm by weight
- Cadmium greater than 20ppm by weight

Battery size: CR2032 (coin cell)

Battery type: Polymer

Battery size: 4-cell or 6-cell high capacity Polymer battery

Additional Information

- This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive - 2011/65/EC.
- This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive – 2002/96/EC.
- This product is in compliance with California Proposition 65 (State of California; Safe Drinking Water and Toxic Enforcement Act of 1986).
- This product is in compliance with the IEEE 1680 (EPEAT) standard at the Gold level, see www.epeat.net
- Plastics parts weighing over 25 grams used in the product are marked per ISO11469 and ISO1043.
- This product contains 0.0% post-consumer recycled plastic (by wt.)
- This product is 95.6% recycle-able when properly disposed of at end of life.

Packaging Materials

External:	PAPER/Corrugated	383 g
Internal:	PLASTIC/Polyethylene Expanded - EPE	90 g
	PLASTIC/Polyethylene low density - LDPE	10 g
	PLASTIC/Polypropylene - PP	5 g

The plastic packaging material contains at least 81.5% recycled content.

The corrugated paper packaging materials contains at least 80 % recycled content.

Material Usage

This product does not contain any of the following substances in excess of regulatory limits (refer to the HP General Specification for the Environment at

<http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/gse.pdf>):

- Asbestos
- Certain Azo Colorants
- Certain Brominated Flame Retardants – may not be used as flame retardants in plastics
- Cadmium
- Chlorinated Hydrocarbons
- Chlorinated Paraffins
- Formaldehyde
- Halogenated Diphenyl Methanes
- Lead carbonates and sulfates
- Lead and Lead compounds
- Mercuric Oxide Batteries

Technical Specifications – Environmental

- Nickel – finishes must not be used on the external surface designed to be frequently handled or carried by the user.
- Ozone Depleting Substances
- Polybrominated Biphenyls (PBBs)
- Polybrominated Biphenyl Ethers (PBBEs)
- Polybrominated Biphenyl Oxides (PBBOs)
- Polychlorinated Biphenyl (PCB)
- Polychlorinated Terphenyls (PCT)
- Polyvinyl Chloride (PVC) – except for wires and cables, and certain retail packaging has been voluntarily removed from most applications.
- Radioactive Substances
- Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO)

Packaging Usage

HP follows these guidelines to decrease the environmental impact of product packaging:

- Eliminate the use of heavy metals such as lead, chromium, mercury and cadmium in packaging materials.
- Eliminate the use of ozone-depleting substances (ODS) in packaging materials.
- Design packaging materials for ease of disassembly.
- Maximize the use of post-consumer recycled content materials in packaging materials.
- Use readily recyclable packaging materials such as paper and corrugated materials.
- Reduce size and weight of packages to improve transportation fuel efficiency.
- Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards.

End-of-life Management and Recycling

HP Inc. offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to: <http://www.hp.com/go/reuse-recycle> or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner.

The EU WEEE directive (2002/95/EC) requires manufacturers to provide treatment information for each product type for use by treatment facilities. This information (product disassembly instructions) is posted on the HP Inc. web site at: <http://www.hp.com/go/recyclers>. These instructions may be used by recyclers and other WEEE treatment facilities as well as HP OEM customers who integrate and re-sell HP equipment.

HP Inc. Corporate Environmental Information

For more information about HP's commitment to the environment:

Global Citizenship Report

<http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html>

Eco-label certifications

<http://www8.hp.com/us/en/hp-information/environment/ecolabels.html>

ISO 14001 certificates:

<http://h20195.www2.hp.com/V2/GetDocument.aspx?docname=c04755842>
and

<http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/cert.pdf>

COUNTRY OF ORIGIN

China



Options and Accessories (sold separately and availability may vary by country)

Type	Description	Part #
Pen	HP ZBook x360 Pen for G5	4WW09AA
	HP ZBook Nib Kit for Active Pen (x360)	4WW10AA
Display	Z27x G2 27-inch DreamColor Studio display	2NJ08A4#xxx
	Z32 31.5-inch 4k UHD Display	1AA81A4#xxx
	Z38c 37.5-inch Curved Display	Z4W65A4#xxx
	Z24n G2 24-inch Display	1JS09A4#xxx
	Z27n G2 27-inch Display	1JS10A4#xxx
Memory	HP 4GB DDR4-2666 SODIMM	4VN05AA#ABA
	HP 8GB DDR4-2666 SODIMM	4VN06UT#ABA
	HP 16GB DDR4-2666 SODIMM	4VN07AA/UT#ABA
	HP 8GB DDR4-2666 ECC SODIMM	4UY11AA
	HP 16GB DDR4-2666 ECC SODIMM	4UY12AA
Cases	HP 15.6 Business Top Load– Refresh	2SC66AA
	HP Exec Black Leather 15.6 Top Load	1LG83AA
	HP Slim Ultrabook Messenger (up to 15.6" x .88"/22/5mm)	F3W14AA
	HP Slim Ultrabook Backpack (up to 15.6" x .88"/22/5mm)	F3W16AA
	HP Essential Backpack (up to 15.6")	H1D24AA
	HP Essential Top Load Case (up to 15.6")	H2W17AA#xxx
Docking	HP Thunderbolt™ B Dock G2 w/Combo Cable	3TR87AA#xxx
	HP Thunderbolt™ Dock 230W G2	2UK38AA
	HP Thunderbolt™ Dock Audio	3AQ21AA
	HP USB-C Mini Dock	1PM64AA
	HP USB-C Dock G4	3FF69AA#xxx
	HP USB-C Universal Dock	1MK33AA
	HP Travel Hub	TOK30AA
	HP 3005pr USB 3.0 Port Replicator w/ USB-C™ Adapter	Y4H06AA
Input/Output - Mice	HP Wireless Premium Mouse	1JR31AA
	HP USB Premium Mouse	1JR32AA
	HP Slim Bluetooth Mouse	F3J92AA#xxx
	HP USB Travel Mouse	G1K28AA#xxx
	HP Comfort Grip Mouse	H2L63AA
	HP X4000 Bluetooth Mouse	H3T50AA#xxx
	HP 3-Button Laser Mouse	H4B81AA#xxx
	HP Ultra Mobile Wireless Mouse	H6F25AA#xxx
	HP Slim Wireless Keyboard and Mouse	T6L04AA
	HP Slim USB Keyboard and Mouse	T6T83AA
	HP Wireless (Link-5) Keyboard	T6U20AA

Options and Accessories (sold separately and availability may vary by country)

Power Adapters	HP 150W Slim Smart AC Adapter	4SC18UT#xxx
	HP 200W Slim Smart AC Adapter	4SC19AA/UT#xxx
Adapters	HP HDMI to DVI adapter	F5A28AA
	HDMI to VGA Adapter	H4F02AA
	USB 3.0 to RJ45	N7P47AA
	HP USB-C™ to VGA Adapter	N9K76AA
	USB-C to RJ45	V7W66AA
	HP USB-C™ to USB Hub	Z6A00AA
Storage - External Storage	HP 256GB M.2 NVME PCIe SSD (2280)	V3K66AA
	HP 512GB M.2 NVME PCIe SSD (2280)	V3K67AA
	HP 256GB TLC PCI-e 3x4 NVMe M.2 SSD	1FU87AA
	HP 512GB TLC PCI-e 3x4 NVMe M.2 SSD	1FU88AA
	HP 1TB 2280 M2 PCIe3x4 SS NVME (MLC)	X2E90AA
	HP External USB DVDRW Drive	F2B56AA
Security	HP Nano Keyed Cable Lock	1AJ39AA
	HP Nano Dual Head Keyed Cable Lock	1AJ41AA
	HP Docking Station Cable Lock	AU656AA#XXX
	HP Keyed Cable Lock	TOY14AA
	HP Combination Lock	TOY15AA
	HP Essential Combination Lock	TOY16AA
	HP Keyed Cable Lock 10mm	T1A62AA
	HP Dual Head Cable Lock (Non-Master key)	T1A64AA
	HP 3-year Next business day onsite Hardware Support w/Accidental Damage Protection-G2 for Notebooks	UF631E
Collaboration	HP Elite Presenter Mouse	ZCE30AA#xxx
	HP UC Conferencing Keyboard	K8P74AA#xxx
	HP Stereo 3.5mm Headset	T1A66AA
	HP Stereo USB Headset	T1A67AA
	HP USB Collaboration Keyboard	Z9N38AA
	HP Wireless Collaboration Keyboard	Z9N39AA#xxx
	HP Wireless Premium Keyboard	Z9N41AA#xxx

Summary of Changes

Date of change:	Version History:		Description of change:
April 6, 2018	From v1 to v2	Changed	Weight section
June 12, 2018	From v2 to v3	Changed	At a glance, Operating system, Graphics, Storage, Drive controllers
June 26, 2018	From v3 to v4	Changed	Processors, Storage and Drives, Software and Security, Power, System Unit sections and format changes
August 27, 2018	From v4 to v5	Changed	Format
October 15, 2018	From v5 to v6	Changed	Added features to support the October Refresh
August 9, 2019	From v6 to v7	Added	9th Generation Intel Core Processors

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